

Product Summary

Designed to protect voltage sensitive electronic components from ESD and other transients. Excellent clamping capability, low leakage, high capacitance, and fast response time provide best in class protection on designs that are exposed to ESD.

The combination of small size, high capacitance, and high level of ESD protection makes them a flexible solution for applications such as HDMI, Display Port TM, and MDDI interfaces. It is designed to replace multilayer varistors (MLV) in consumer equipments applications such as mobile phone, notebook, PAD, STB, LCD TV etc.

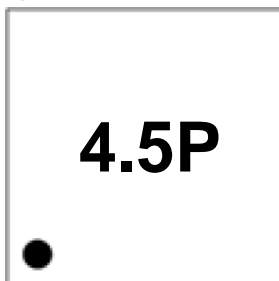
Feature

- Low reverse stand-off voltage: 4.5V
- Low reverse clamping voltage
- Low leakage current
- Fast response time
- JESD22-A114-B ESD Rating of class 3B per human body model
- IEC 61000-4-2 Level 4 ESD protection

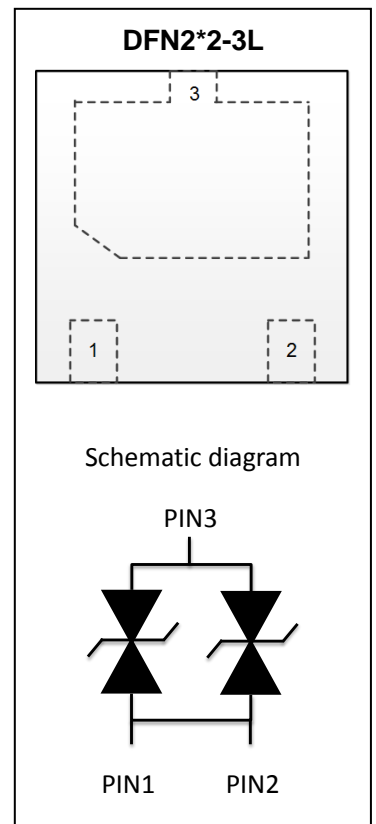
Application

- Computers and peripherals
- Portable electronics
- Power lines
- Audio and video equipment
- Cellular handsets and accessories
- Other electronic equipment communication systems

Marking:



4.5P =Device Code



Absolute Maximum Ratings ($T_a=25^{\circ}\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
IEC 61000-4-2 ESD Voltage	$V_{\text{ESD}}^{1)}$	± 30	kV
IEC 61000-4-2 ESD Voltage		± 30	
JESD22-A114-B ESD Voltage		± 16	
ESD Voltage		± 0.4	
Peak Pulse Power	$P_{\text{PP}}^{2)}$	5000	W
Peak Pulse Current	$I_{\text{PP}}^{2)}$	250	A
Lead Solder Temperature – Maximum (10 Second Duration)	T_L	260	$^{\circ}\text{C}$
Junction Temperature	T_j	150	$^{\circ}\text{C}$
Storage Temperature	T_{stg}	-55~ +150	$^{\circ}\text{C}$

- 1) Device stressed with ten non-repetitive ESD pulses.
- 2) Non-repetitive current pulse 8/20 μs exponential decay waveform according to IEC61000-4-5.

ESD standards compliance

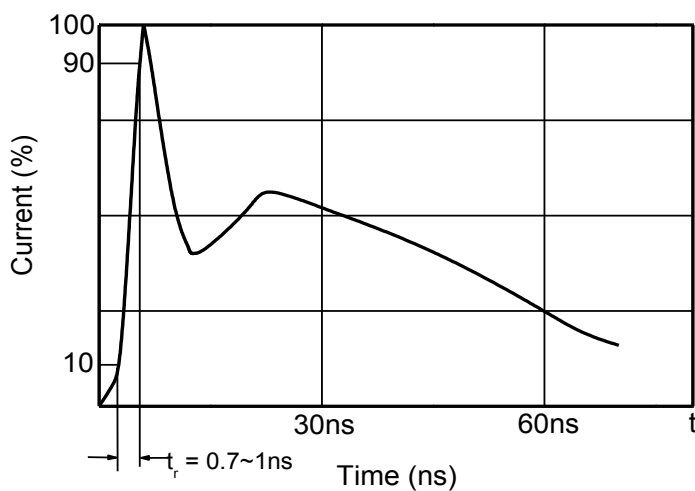
IEC61000-4-2 Standard

Contact Discharge		Air Discharge	
Level	Test Voltage kV	Level	Test Voltage kV
1	2	1	2
2	4	2	4
3	6	3	8
4	8	4	15

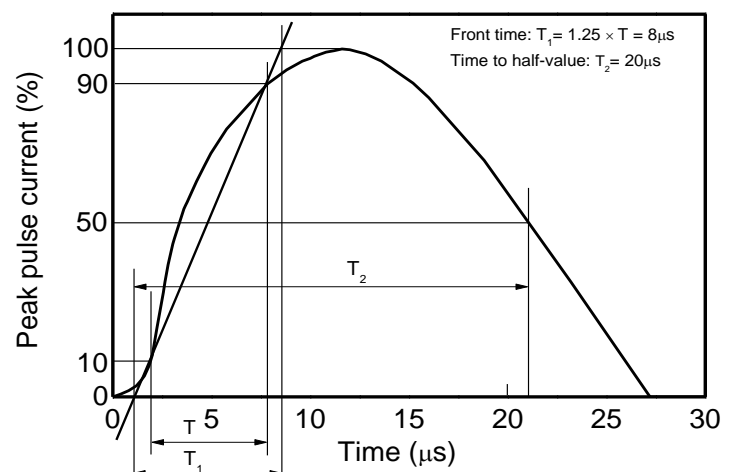
JESD22-A114-B Standard

ESD Class	Human Body Discharge V
0	0~249
1A	250~499
1B	500~999
1C	1000~1999
2	2000~3999
3A	4000~7999
3B	8000~15999

Contact discharge current waveform per IEC61000-4-2

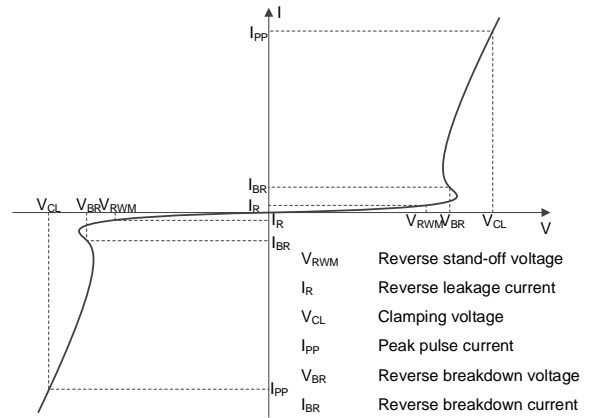


8/20 μs waveform per IEC61000-4-5



Electrical Parameter

Symbol	Parameter
V _C	Clamping Voltage @ I _{PP}
I _{PP}	Peak Pulse Current
V _{BR}	Breakdown Voltage @ I _{BR}
I _{BR}	Test Current
I _R	Reverse Leakage Current @ V _{RWM}
V _{RWM}	Reverse Standoff Voltage



V-I characteristics for a Bi-directional TVS

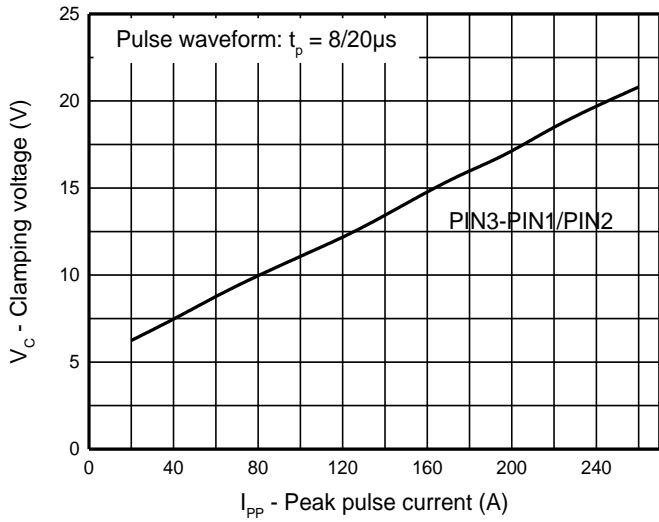
Electrical Characteristics (Ta=25°C unless otherwise specified)

Parameter	Symbol	Test conditions	Min	Typ	Max	Unit
Reverse stand-off voltage	V _{RWM} ¹⁾				4.5	V
Reverse leakage current	I _R	V _{RWM} =4.5V			1	uA
Breakdown voltage	V _{BR}	I _T =1mA	4.7		6	V
Clamping voltage	V _C ²⁾	I _{PP} =250A		20		V
Junction capacitance	C _J	V _R =0V, f=1MHz		500		pF

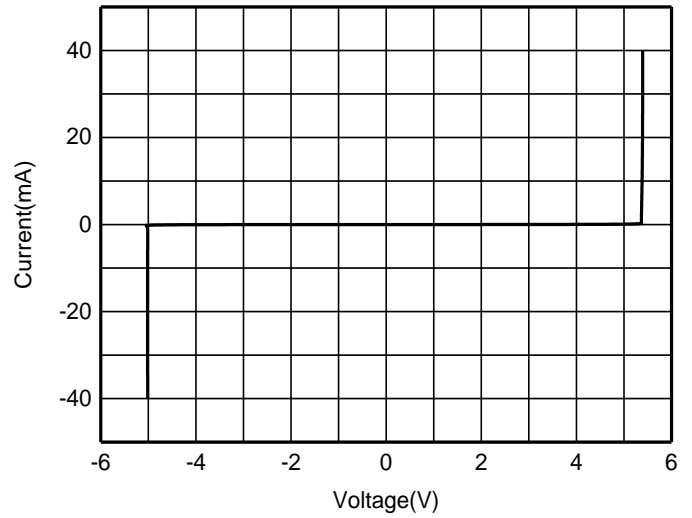
- 1) Other voltages available upon request.
- 2) Non-repetitive current pulse 8/20μs exponential decay waveform according to IEC61000-4-5

Typical Characteristics

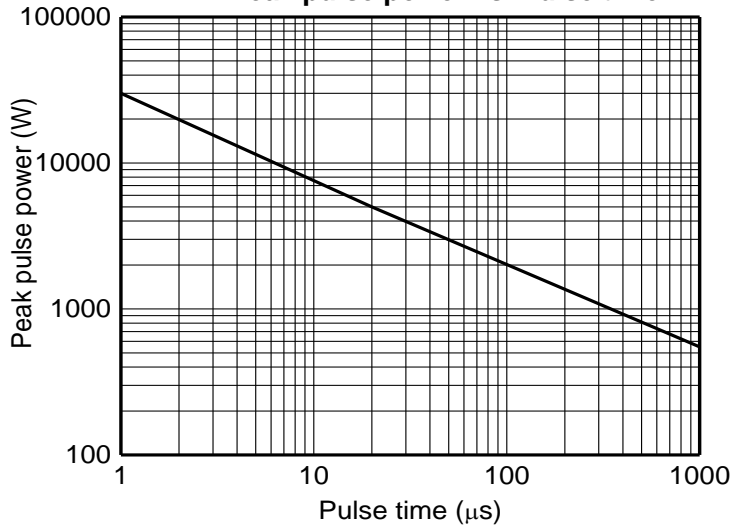
V_C vs. I_{PP}



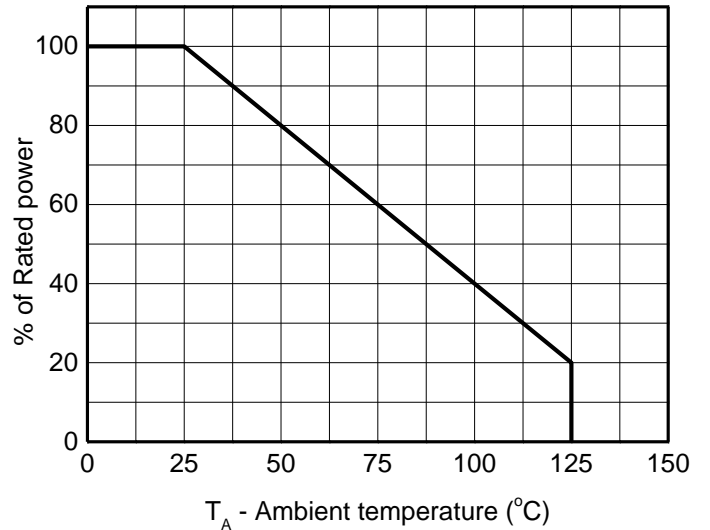
I-V Curve



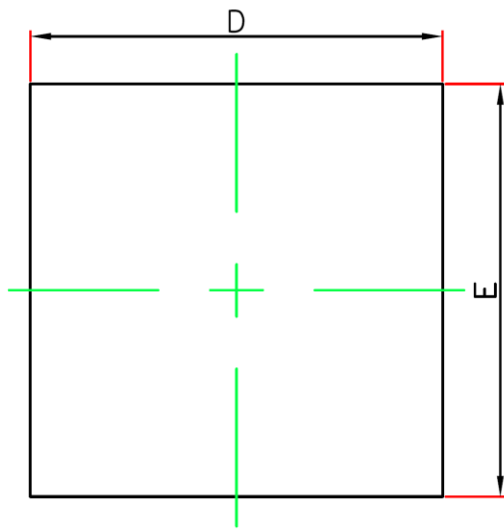
Peak pulse power vs. Pulse time



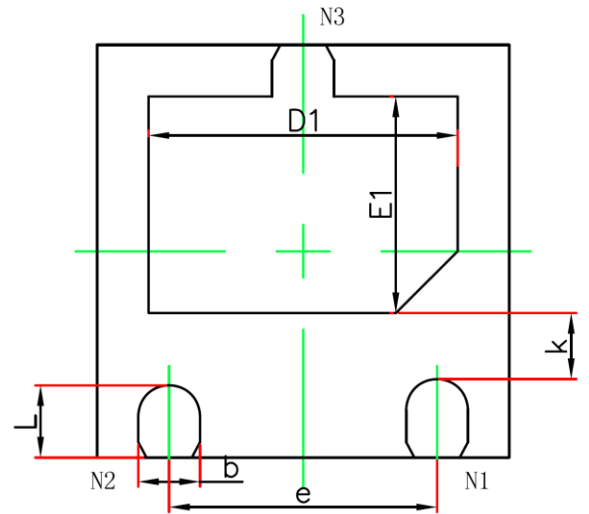
Power derating vs. Ambient temperature



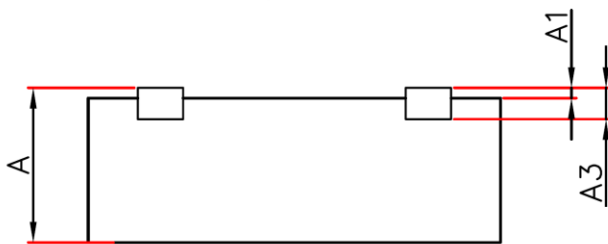
DFN2*2-3L Package Outline Dimensions



TOP VIEW
[顶视图]



BOTTOM VIEW
[背视图]



SIDE VIEW
[侧视图]

Symbol	Dimensions In Millimeters	
	Min.	Max.
A	0.550	0.650
A1	0.000	0.050
A3	0.152REF.	
D	1.924	2.076
E	1.924	2.076
D1	1.400	1.600
E1	0.950	1.150
K	0.220Min.	
b	0.250	0.350
e	1.30(BSC)	
L	0.330	0.430